

Title: LS reply on "3GPP-specific Diameter applications"
Source: SA5
Agenda item: 5.2
Document for: INFORMATION

3GPP TSG-SA5 (Telecom Management)
Meeting #29, Beijing, CHINA, 24 - 28 June 2002

S5-024244

Title: LS reply on "3GPP-specific Diameter applications"
Response to: LS (N4-020732/S5-020443) on "3GPP specific Diameter applications" from CN4
Release: Rel-5
Work Item: OAM-CH (Charging)

Source: SA5
To: CN4
Cc: SA, CN

Contact Person:

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Attachments: None.

1. Overall Description:

SA5 would like to thank CN4 for their LS (N4-020732/S5-020443) on "3GPP specific Diameter applications".

SA5 would further like to inform CN4 that SA5 is currently working on a vendor-specific accounting application for the IMS, where the vendor is 3GPP.

And as requested in the LS by CN4, SA5 is also happy to let CN4 co-ordinate the namespace for 3GPP-specific Diameter applications.

The accounting application developed by SA5 is defined in TS 32.225. This specification also contains information about vendor-specific Attribute Value Pairs (AVPs) that SA5 has planned to use.

SA5 is not planning to use any vendor-specific commands in the accounting application.

2. Actions:

To CN4, CN and SA

ACTION: SA5 kindly requests CN4 to allocate a range of AVP codes (a few hundred) that SA5 can use for its accounting application.

Please note that TS 32.225 is targetted for approval by SA#17 in September 2002.

3. Date of Next SA5 Meetings:

Meeting	Date	Location	Host
SA5#30	19-23 Aug 2002	Tampere, FINLAND	NOKIA
SA5#31	7-11 Oct 2002	Atlanta, GA, USA	NA Friends
SA5#32	18-22 Nov 2002	Vienna, AUSTRIA	EF3